## Designer's™ Data Sheet

# Insulated Gate Bipolar Transistor N-Channel Enhancement-Mode Silicon Gate

This Insulated Gate Bipolar Transistor (IGBT) uses an advanced termination scheme to provide an enhanced and reliable high voltage–blocking capability. Its new 600 V IGBT technology is specifically suited for applications requiring both a high temperature short circuit capability and a low  $V_{CE(on)}$ . It also provides fast switching characteristics and results in efficient operation at high frequencies. This new E–series introduces an energy efficient, ESD protected, and short circuit rugged device.

- Industry Standard TO-220 Package
- High Speed: E<sub>off</sub> = 60 μJ/A typical at 125°C
- High Voltage Short Circuit Capability 10 μs minimum at 125°C, 400 V
- Low On–Voltage 2.0 V typical at 5.0 A, 125°C
- Robust High Voltage Termination
- ESD Protection Gate–Emitter Zener Diodes



# MGP7N60E

IGBT IN TO-220 9.0 A @ 90°C 10 A @ 25°C 600 VOLTS SHORT CIRCUIT RATED LOW ON-VOLTAGE



#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

Rating	Symbol	Value	Unit	
Collector–Emitter Voltage	VCES	600	Vdc	
Collector–Gate Voltage (R <sub>GE</sub> = 1.0 MΩ)	VCGR	600	Vdc	
Gate-Emitter Voltage — Continuous	V <sub>GE</sub>	±20	Vdc	
Collector Current — Continuous @ T <sub>C</sub> = 25°C — Continuous @ T <sub>C</sub> = 90°C — Repetitive Pulsed Current (1)	I <sub>C25</sub> I <sub>C90</sub> I <sub>СМ</sub>	10 7.0 14	Adc Apk	
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	81 0.65	Watts W/°C	
Operating and Storage Junction Temperature Range	TJ, Tstg	-55 to 150	°C	
Short Circuit Withstand Time (V <sub>CC</sub> = 400 Vdc, V <sub>GE</sub> = 15 Vdc, T <sub>J</sub> = 125°C, R <sub>G</sub> = 20 $\Omega$ )	t <sub>sc</sub>	10	μs	
Thermal Resistance — Junction to Case – IGBT — Junction to Ambient	R <sub>θ</sub> JC R <sub>θ</sub> JA	1.5 65	°C/W	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 5 seconds	TL	260	°C	
Mounting Torque, 6–32 or M3 screw	10 lbf•in (1.13 N•m)			

(1) Pulse width is limited by maximum junction temperature. Repetitive rating.

Designer's Data for "Worst Case" Conditions — The Designer's Data Sheet permits the design of most circuits entirely from the information presented. SOA Limit curves — representing boundaries on device characteristics — are given to facilitate "worst case" design.

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### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C unless otherwise noted)

Cha	racteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Collector-to-Emitter Breakdown Voltage ( $V_{GE} = 0 Vdc, I_C = 25 \mu Adc$ ) Temperature Coefficient (Positive)		V <sub>(BR)</sub> CES	600 —	 870	_	Vdc mV/°C
Emitter-to-Collector Breakdown Voltage (V <sub>GE</sub> = 0 Vdc, I <sub>EC</sub> = 100 mAdc)		V(BR)ECS	15	—	_	Vdc
Zero Gate Voltage Collector Current $(V_{CE} = 600 \text{ Vdc}, V_{GE} = 0 \text{ Vdc})$ $(V_{CE} = 600 \text{ Vdc}, V_{GE} = 0 \text{ Vdc}, T_J = 125^{\circ}\text{C})$		ICES		=	10 200	μAdc
Gate–Body Leakage Current (V <sub>GE</sub> = $\pm$ 20 Vdc, V <sub>CE</sub> = 0 Vdc)		IGES	_	-	50	μAdc
ON CHARACTERISTICS (1)		-			•	
Collector-to-Emitter On-State Volt (V <sub>GE</sub> = 15 Vdc, I <sub>C</sub> = 2.5 Adc) (V <sub>GE</sub> = 15 Vdc, I <sub>C</sub> = 2.5 Adc, T <sub>J</sub> (V <sub>GE</sub> = 15 Vdc, I <sub>C</sub> = 5.0 Adc, T <sub>J</sub>	= 125°C)	VCE(on)		1.6 1.5 2.0	1.9 — 2.4	Vdc
Gate Threshold Voltage ( $V_{CE} = V_{GE}$ , $I_C = 1.0$ mAdc) Threshold Temperature Coefficient	nt (Negative)	VGE(th)	4.0	6.0 10	8.0 —	Vdc mV/°C
Forward Transconductance (V <sub>CE</sub> =	= 10 Vdc, I <sub>C</sub> = 5.0 Adc)	9fe	—	2.5	—	Mhos
YNAMIC CHARACTERISTICS						
Input Capacitance	(V <sub>CE</sub> = 25 Vdc, V <sub>GE</sub> = 0 Vdc, f = 1.0 MHz)	Cies		610	—	pF
Output Capacitance		C <sub>oes</sub>	—	60	-	
Transfer Capacitance	- ,	Cres	—	10	-	
SWITCHING CHARACTERISTICS (	1)					
Turn-On Delay Time		<sup>t</sup> d(on)		22	-	ns
Rise Time	$(V_{CC} = 360 \text{ Vdc}, I_{C} = 5.0 \text{ Adc},$	tr	-	24	-	
Turn–Off Delay Time	$V_{GE}$ = 15 Vdc, L = 300 µH, $R_{G}$ = 20 Ω, T <sub>J</sub> = 25°C) Energy losses include "tail"	<sup>t</sup> d(off)		64	-	
Fall Time		t <sub>f</sub>	-	196	-	
Turn–Off Switching Loss		E <sub>off</sub>	—	0.20	0.34	mJ
Turn-On Delay Time		<sup>t</sup> d(on)	—	31	-	ns
Rise Time	$(V_{CC} = 360 \text{ Vdc}, I_{C} = 5.0 \text{ Adc},$	tr	—	24	-	
Turn-Off Delay Time	$V_{GE}$ = 15 Vdc, L = 300 µH, R <sub>G</sub> = 20 Ω, T <sub>J</sub> = 125°C) Energy losses include "tail"	<sup>t</sup> d(off)	—	195	—	
Fall Time		tf	_	220	—	
Turn–Off Switching Loss		E <sub>off</sub>	_	0.38	-	mJ
Gate Charge $(V_{CC} = 360 \text{ Vdc}, I_C = 5.0 \text{ Adc} \\ V_{GE} = 15 \text{ Vdc})$		QT	—	27.2	-	nC
	(V <sub>CC</sub> = 360 Vdc, I <sub>C</sub> = 5.0 Adc, V <sub>GE</sub> = 15 Vdc)	Q <sub>1</sub>	—	7.0	—	
		Q <sub>2</sub>	_	13.7	—	
NTERNAL PACKAGE INDUCTANC	E					
Internal Emitter Inductance (Measured from the emitter lead 0.25" from package to emitter bond pad)		LE	_	7.5	_	nH

(1) Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%.

### MGP7N60E



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#### PACKAGE DIMENSIONS



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